

7NM65

Preliminary

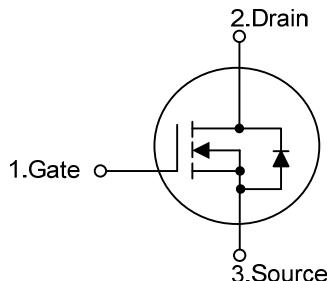
Power MOSFET**7A, 650V N-CHANNEL
SUPER-JUNCTION MOSFET****■ DESCRIPTION**

The UTC **7NM65** is an Super Junction MOSFET Structure. It uses UTC advanced planar stripe, DMOS technology to provide customers perfect switching performance, minimal on-state resistance.

The UTC **7NM65** is universally applied in electronic lamp ballasts based on half bridge topology, high efficiency switched mode power supplies, active power factor correction, etc.

■ FEATURES

- * Low drain-source on-resistance: $R_{DS(ON)} < 0.9 \Omega$ (max.) by using Super Junction Structure
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

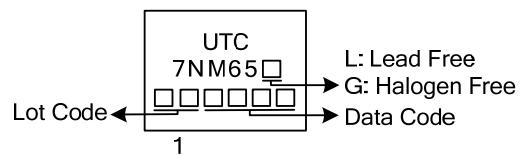
■ SYMBOL**■ ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
7NM65L-TF3-T	7NM65G-TF3-T	TO-220	G	D	S	Tube
7NM65L-TA3-T	7NM65G-TA3-T	TO-220F	G	D	S	Tube
7NM65L-TM3-T	7NM65G-TM3-T	TO-251	G	D	S	Tube
7NM65L-TN3-R	7NM65G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 7NM65L-TA3-T (1)Packing Type (2)Package Type (3) Green Package	(1) T: Tube, R: Tape Reel
	(2) TA3: TO-220, TF3: TO-220F, TM3: TO-251
	TN3: TO-252
(3) L: Lead Free, G: Halogen Free and Lead Free	

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	650	V
Gate-Source Voltage	V_{GSS}	± 30	V
Avalanche Current (Note 2)	I_{AR}	2	A
Drain Current	Continuous I_D	7	A
	Pulsed (Note 2) I_{DM}	28	A
Avalanche Energy	Single Pulsed (Note 3) E_{AS}	60	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	P_D	48	W
		60	
Junction Temperature	T_J	+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. $L = 30\text{mH}$, $I_{AS} = 2\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 7\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
TO-251/TO-252		110	
Junction to Case	θ_{JC}	2.6	$^\circ\text{C}/\text{W}$
TO-220F/TO-220F1		2.08	

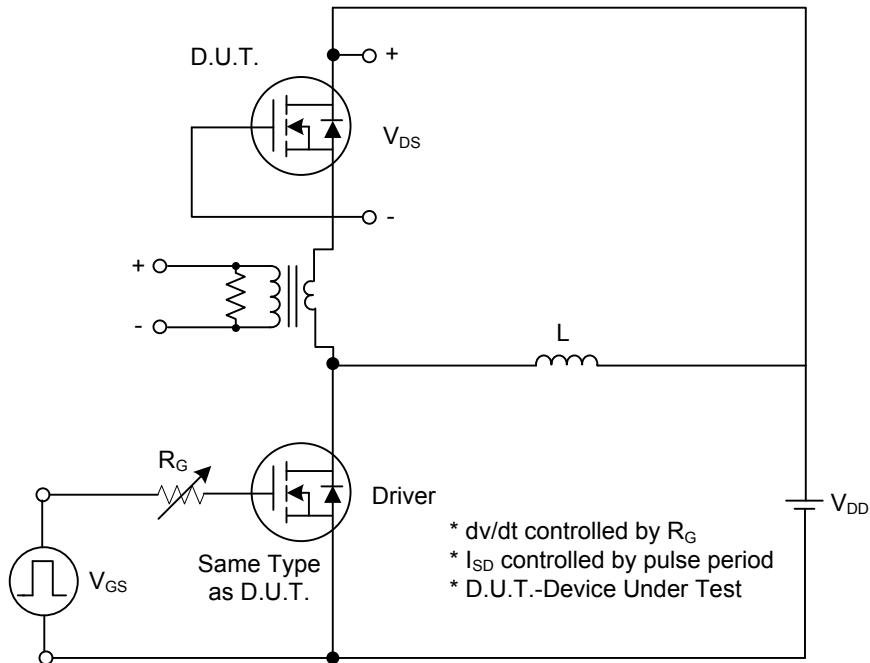
■ ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	650			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 650\text{V}, V_{\text{GS}} = 0\text{V}$		1		μA
Gate- Source Leakage Current	Forward	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
	Reverse	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{V}, I_D = 3.5\text{A}$		0.9		Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0 \text{ MHz}$		375		pF
Output Capacitance	C_{OSS}			238		pF
Reverse Transfer Capacitance	C_{RSS}			26		pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DD}} = 30\text{V}, I_D = 0.5\text{A}, R_G = 25\Omega$ (Note 1, 2)		50		ns
Turn-On Rise Time	t_R			95		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			160		ns
Turn-Off Fall Time	t_F			85		ns
Total Gate Charge	Q_G	$V_{\text{DS}}=50\text{V}, I_D=1.3\text{A}, V_{\text{GS}}=10 \text{ V}$ (Note 1, 2)		21		nC
Gate-Source Charge	Q_{GS}			5		nC
Gate-Drain Charge	Q_{GD}			5.8		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = 7 \text{ A}$			1.4	V
Maximum Continuous Drain-Source Diode Forward Current	I_S				7	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				28	A

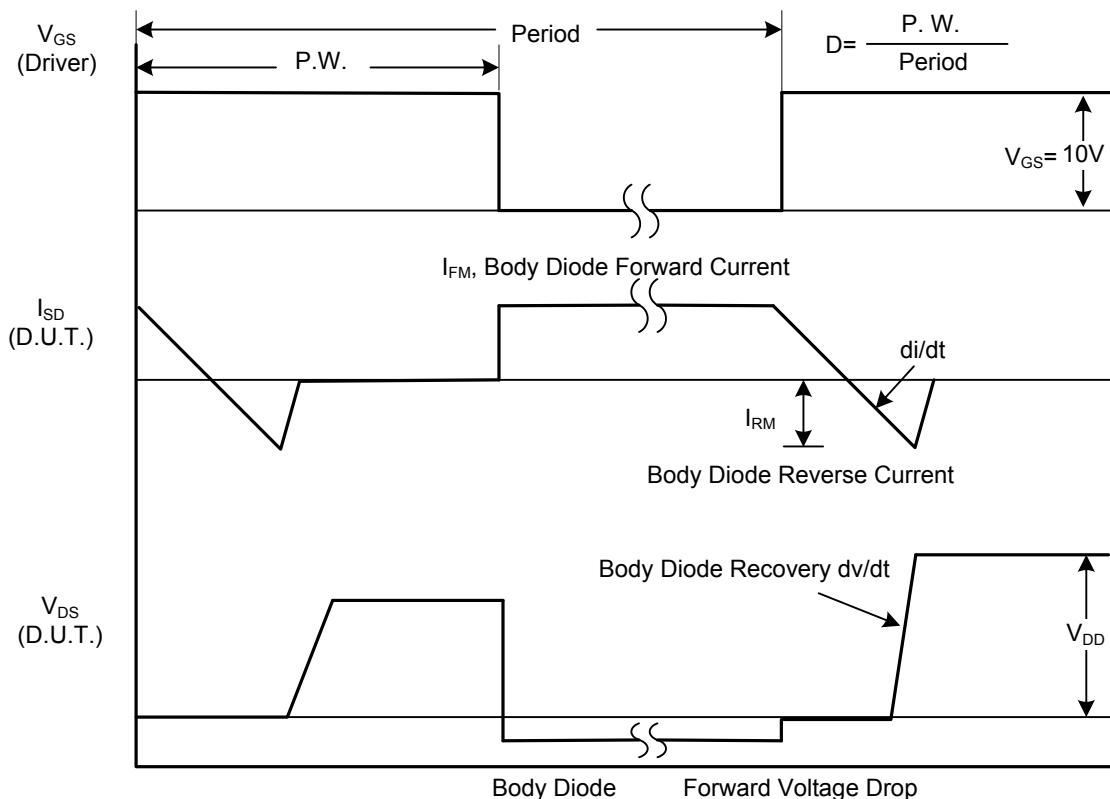
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

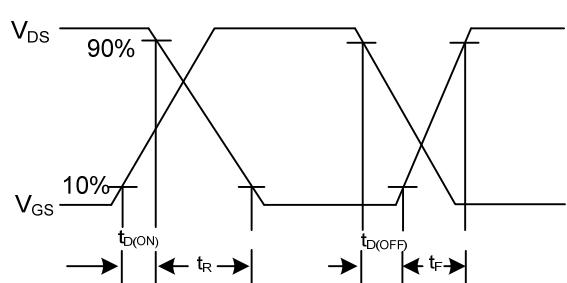
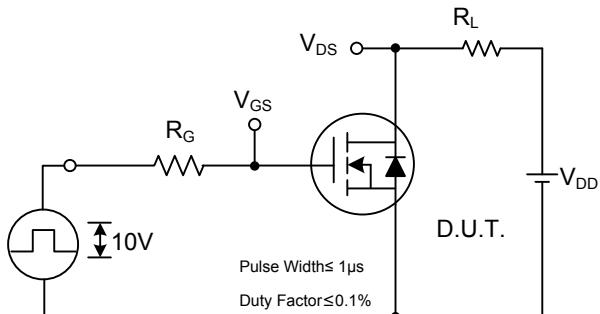


Peak Diode Recovery dv/dt Test Circuit



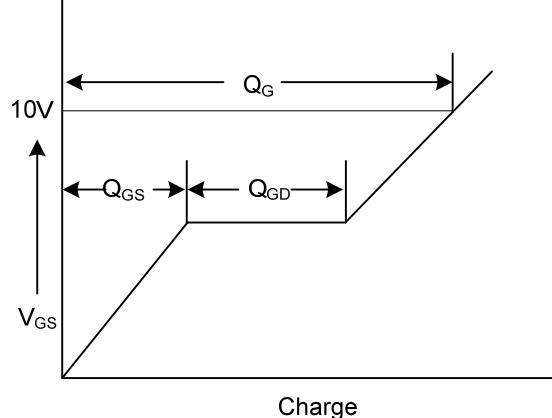
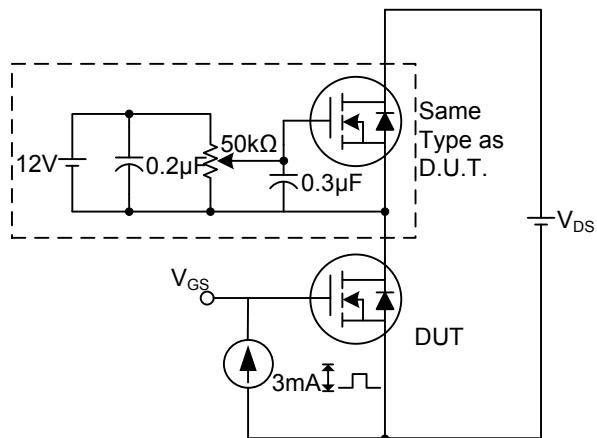
Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)



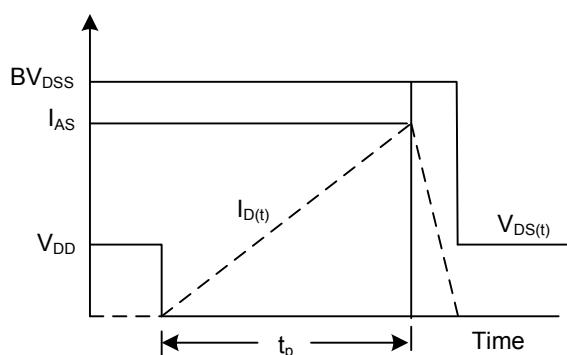
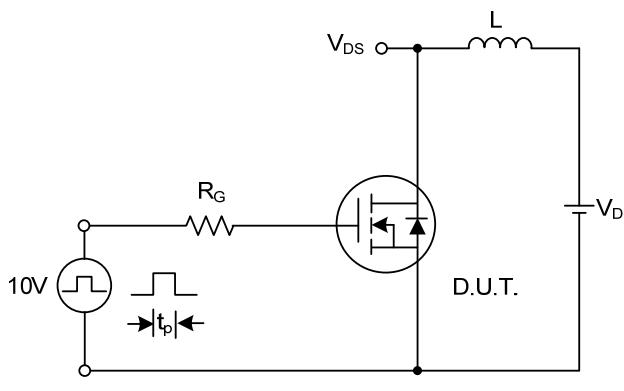
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

Gate Charge Waveform



Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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